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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Data Sheet No. PD60186 revE IR2170(S) & (PbF)

This part is no longer recommended for new designs; please use IR2175, IR2177, IR21771, IR2277 or IR22771.

#### **Features**

- Floating channel up to +600V
- Monolithic integration
- · Overcurrent sensing through shunt resistor
- Low IQBS allows the boot strap power supply
- Independent fast 1µsec overcurrent trip signal
- · High common mode noise immunity
- Input overvoltage protection for IGBT short circuit condition
- Open Drain outputs
- Available in Lead-Free

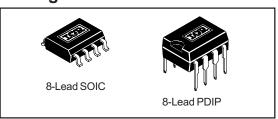
#### **Description**

IR2170(S) is the monolithic over current sensing IC designed for motor drive applications. It senses the motor phase current through an external shunt resistor, detects overcurrent condition, and transfers the signal to the low side. IR's proprietary high voltage isolation technology is implemented to enable the high bandwidth signal processing. The dedicated overcurrent trip (OC) signal facilitates IGBT short circuit protection. The OC output pulse width can be programmed by the external resistor and capacitor. The open-drain outputs make easy for any interface from 3.3V to 15V.

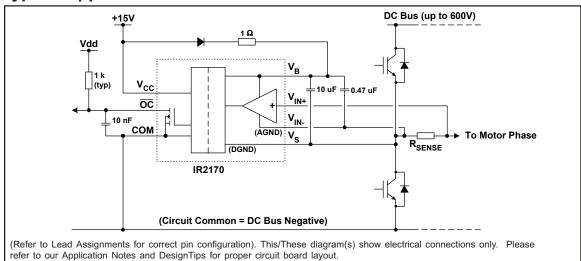
# **OVER CURRENT SENSING IC Product Summary**

| Voffset                          | 600Vmax         |
|----------------------------------|-----------------|
| I <sub>QBS</sub>                 | 1mA             |
| Overcurrent trip<br>signal delay | 1.5usec (typ)   |
| Overcurrent trip level           | +/-260mV (typ.) |
|                                  |                 |

#### **Packages**



# Typical Application



## **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol            | Definition  |                   | Min.                | Max.     | Units |  |
|-------------------|---|-------------------|---------------------|----------|-------|--|
| Vs                | High side offset voltage  |                   | -0.3                | 600      |       |  |
| V <sub>BS</sub>   | High side floating supply voltage                                 |                   | -0.3                | 25       |       |  |
| V <sub>CC</sub>   | Low side and logic fixed supply voltage                           |                   | -0.3                | 25       |       |  |
| V <sub>IN</sub>   | Maximum input voltage between V <sub>IN+ and</sub> V <sub>I</sub> | N-                | -5                  | 5        | V     |  |
| Voc               | Overcurrent output voltage  |                   | COM-0.3             | VCC +0.3 |       |  |
| V <sub>IN-</sub>  | V <sub>IN-</sub> input voltage (note 1)                           | V <sub>S</sub> -5 | V <sub>B+</sub> 0.3 |          |       |  |
| dV/dt             | Allowable offset voltage slew rate                                |                   | _                   | 50       | V/ns  |  |
| PD                | Package power dissipation @ T <sub>A</sub> ≤ +25°C                | 8 lead SOIC       | _                   | .625     |       |  |
|                   |   | 8 lead PDIP       | _                   | 1.0      | W     |  |
| Rth <sub>JA</sub> | Thermal resistance, junction to ambient                           | 8 lead SOIC       | _                   | 200      | °C/W  |  |
|                   |   | 8 lead PDIP       | _                   | 125      |       |  |
| TJ                | Junction temperature  |                   | _                   | 150      |       |  |
| T <sub>S</sub>    | Storage temperature   |                   | -55                 | 150      | °C    |  |
| TL                | Lead temperature (soldering, 10 seconds)                          |                   | _                   | 300      |       |  |

Note 1: Capacitors are required between VB and Vin-, and between VB and Vs pins when bootstrap power is used. The external power supply, when used, is required between Vs and Vin-, and between VB and Vs pins.

## **Recommended Operating Conditions**

The output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions.

| Symbol          | Definition  | Min.                 | Max.               | Units |
|-----------------|---|----------------------|--------------------|-------|
| V <sub>B</sub>  | High side floating supply voltage                           | V <sub>S</sub> +13.0 | V <sub>S</sub> +20 |       |
| Vs              | High side floating supply offset voltage                    | note 2               | 600                |       |
| Voc             | Overcurrent output voltage                                  | COM                  | VCC                | V     |
| Vcc             | Low side and logic fixed supply voltage                     | 9.5                  | 20                 |       |
| V <sub>IN</sub> | Input voltage between V <sub>IN+</sub> and V <sub>IN-</sub> | -260                 | +260               | mV    |
| T <sub>A</sub>  | Ambient temperature   | -40                  | 125                | °C    |

Note 2: Logic operation for Vs of -5 to +600V. Logic state held for Vs of -5V to -VBS. (Please refer to the Design Tip DT97-3 for more details).

## **DC Electrical Characteristics**

 $V_{CC} = V_{BS} = 15V$ , and  $T_A = 25^{\circ}C$  unless otherwise specified.

| Symbol            | Definition                               | Min. | Тур. | Max. | Units | <b>Test Conditions</b>                 |
|-------------------|--|------|------|------|-------|--|
| V <sub>OC+</sub>  | Overcurrent trip positive input voltage  | _    | 260  |      |       |  |
| V <sub>OC</sub> - | Overcurrent trip negative input voltage  | _    | -260 |      | mV    |  |
| I <sub>LK</sub>   | Offset supply leakage current            | _    | _    | 50   | μA    | V <sub>B</sub> = V <sub>S</sub> = 600V |
| I <sub>QBS</sub>  | Quiescent V <sub>BS</sub> supply current | _    | 1    | 2    |       | V <sub>S</sub> = 0V                    |
| IQCC              | Quiescent V <sub>CC</sub> supply current | _    | _    | 0.5  | A     |  |
| locc              | OC output sink current                   | 10   | _    |      | mA    | V <sub>O</sub> = 1V                    |
|                   |  | 1    | _    | _    |       | V <sub>O</sub> = 0.1V                  |

# **AC Electrical Characteristics**

 $V_{CC} = V_{BS} = 15V$ , and  $T_A = 25^{\circ}C$  unless otherwise specified.

| Symbol    | Definition                   | Min. | Тур. | Max. | Units | Test Conditions |
|-----------|------------------------------|------|------|------|-------|-----------------|
| Proagatio | n delay characteristics      |      |      |      |       |                 |
| tdoc      | Propagation delay time of OC | 1    | 1.5  | _    | usec  |                 |
| twoc      | Low true pulse width of OC   | _    | 1    | _    |       |                 |

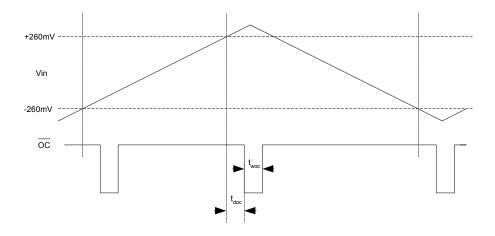


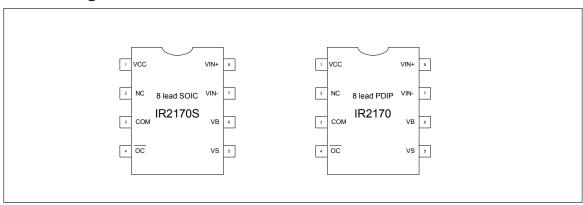
Figure 1. OC Waveform

# IR2170(S)&(PbF)

# **Lead Definitions**

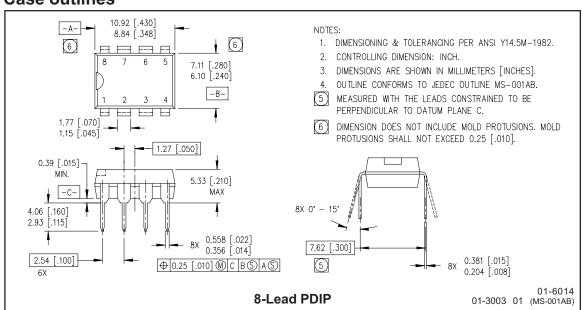
| Symbol           | Description                         |
|------------------|-------------------------------------|
| Vcc              | Low side and logic supply voltage   |
| COM              | Low side logic ground               |
| V <sub>IN+</sub> | Positive sense input                |
| VIN-             | Negative sense input                |
| VB               | High side supply                    |
| Vs               | High side return                    |
| <u>oc</u>        | Overcurrent output (negative logic) |
| N.C.             | No connection                       |

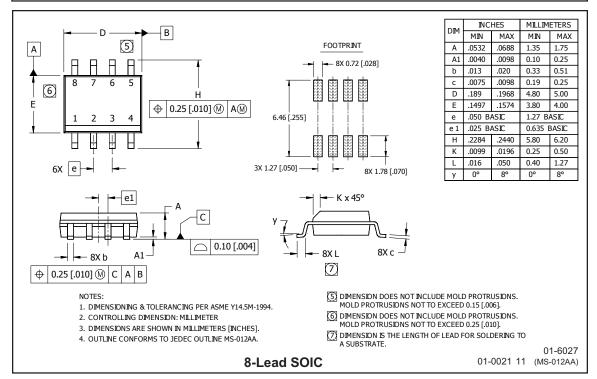
# **Lead Assignments**



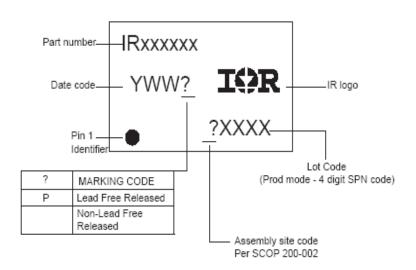
# IR2170(S)&(PbF)

## **Case outlines**





# LEADFREE PART MARKING INFORMATION



#### **ORDER INFORMATION**

#### Basic Part (Non-Lead Free)

#### **Lead-Free Part**

| 8-Lead PDIP IR2170  | order IR2170  | 8-Lead PDIP IR2170  | order IR2170PbF  |
|---------------------|---------------|---------------------|------------------|
| 8-Lead SOIC IR2170S | order IR2170S | 8-Lead SOIC IR2170S | order IR2170SPbF |



This product has been designed and qualified for the Industrial market.

Qualification Standards can be found on IR's Web Site.

Data and specifications subject to change without notice.

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

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